

0.5 A low V_F MEGA Schottky barrier rectifier Rev. 1 — 12 April 2011

Product data sheet

Product profile 1.

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD882D leadless ultra small Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

1.2 Features and benefits

- Forward current: I_F ≤ 0.5 A
- Reverse voltage: V_R ≤ 30 V
- Low forward voltage: $V_F \le 500 \text{ mV}$
- AEC-Q101 qualified
- Ultra small and leadless SMD plastic package
- Solderable side pads
- Package height typ. 0.37 mm

1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- Low power consumption applications

1.4 Quick reference data

| $\begin{tabular}{ c c c c c } \hline Symbol & Parameter & Conditions & Min & Typ & Max \\ \hline I_{F(AV)} & average forward current & square wave; $\delta = 0.5$; $f = 20 kHz & & & & & & & \\ \hline T_{amb} \leq 75 \ ^{\circ}C & \underline{[1]} \ - & - & 0.5 & \\ \hline T_{sp} \leq 130 \ ^{\circ}C & - & - & 0.5 & \\ \hline I_R & reverse current & V_R = 10 \ V & - & 15 & 200 & & & \\ \hline I_{amb} & I_{a$ | |
|---|------|
| current f = 20 kHz $T_{amb} \le 75 \ ^{\circ}C$ [1] - - 0.5 $T_{sp} \le 130 \ ^{\circ}C$ - - 0.5 I _R reverse current V _R = 10 V - 15 200 | Unit |
| $\begin{tabular}{c c c c c c c c c c c c c c c c c c c $ | |
| I_R reverse current $V_R = 10 V$ - 15 200 | А |
| | А |
| | μΑ |
| V _R reverse voltage 30 | V |
| $V_{\rm F}$ forward voltage $I_{\rm F} = 500 \text{ mA}$ [2] - 450 500 | mV |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[2] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

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2. Pinning information

| Pin | Description | Simplified outline | Graphic symbol |
|-----|-------------|-------------------------|------------------------|
| 1 | cathode | [1] | |
| 2 | anode | | 1 <u>+</u> 2 sym001 |
| | | Transparent top view | |

[1] The marking bar indicates the cathode.

3. Ordering information

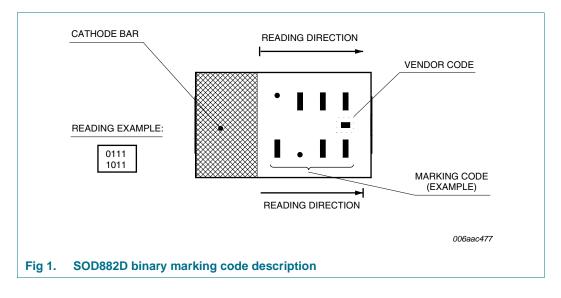
| Table 3. Ordering | information | | |
|-------------------|-------------|--|---------|
| Type number | Package | | |
| | Name | Description | Version |
| PMEG3005ELD | - | leadless ultra small plastic package; 2 terminals; body 1 \times 0.6 \times 0.4 mm | SOD882D |

4. Marking

| Table 4. Marking codes | |
|------------------------|-----------------------------|
| Type number | Marking code ^[1] |
| PMEG3005ELD | 0011 0000 |

[1] For SOD882D binary marking code description, see Figure 1.

4.1 Binary marking code description



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5. Limiting values

| Table 5. In accorda | Limiting values ance with the Absolute Max | timum Rating System (IEC | 60134). | | |
|------------------------|---|--|--------------|------|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| V _R | reverse voltage | | - | 30 | V |
| I _{F(AV)} | average forward current | square wave; δ = 0.5; f = 20 kHz | | | |
| | | $T_{amb} \le 75 \ ^{\circ}C$ | <u>[1]</u> _ | 0.5 | А |
| | | $T_{sp} \le 130 \ ^{\circ}C$ | - | 0.5 | А |
| I _{FRM} | repetitive peak forward current | $t_p \leq 1 \text{ ms; } \delta \leq 0.25$ | - | 1 | A |
| I _{FSM} | non-repetitive peak forward current | square wave; t _p = 8 ms | [2] _ | 3 | A |
| P _{tot} | total power dissipation | $T_{amb} \leq 25 \ ^{\circ}C$ | <u>[3]</u> _ | 340 | mW |
| | | | <u>[1]</u> - | 660 | mW |
| | | | [4] _ | 1000 | mW |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | ambient temperature | | -55 | +150 | °C |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| | | | | | |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[2] $T_j = 25 \ ^{\circ}C$ prior to surge.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[4] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

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6. Thermal characteristics

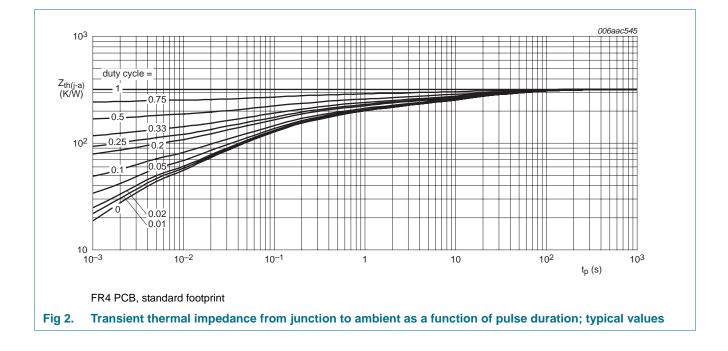
| Table 6. | Thermal characteristics | | | | | |
|-----------------------|--|-------------|-----------------|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| R _{th(j-a)} | thermal resistance from | in free air | <u>[1][2]</u> _ | - | 370 | K/W |
| | junction to ambient | | <u>[1][3]</u> | - | 190 | K/W |
| | | | <u>[1][4]</u> _ | - | 125 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | <u>[5]</u> _ | - | 50 | K/W |

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

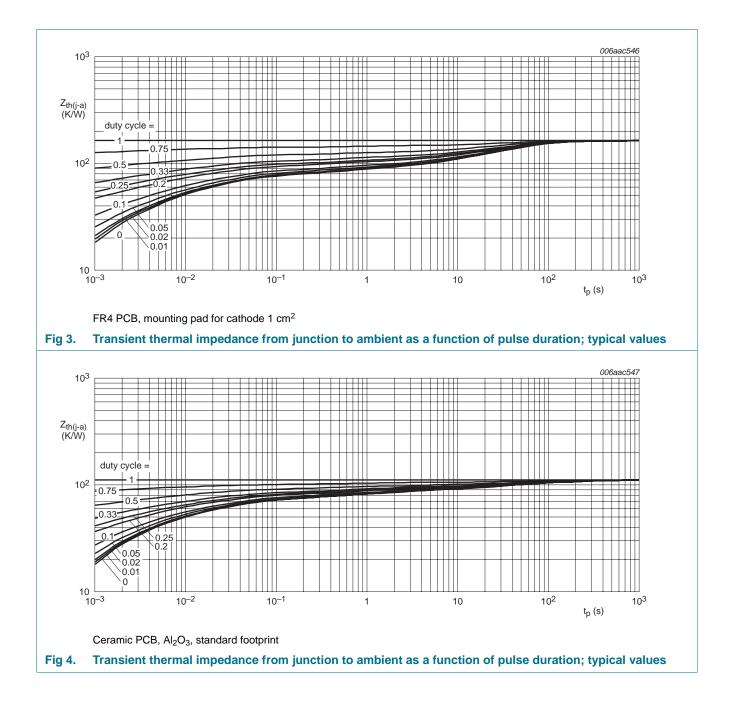
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.



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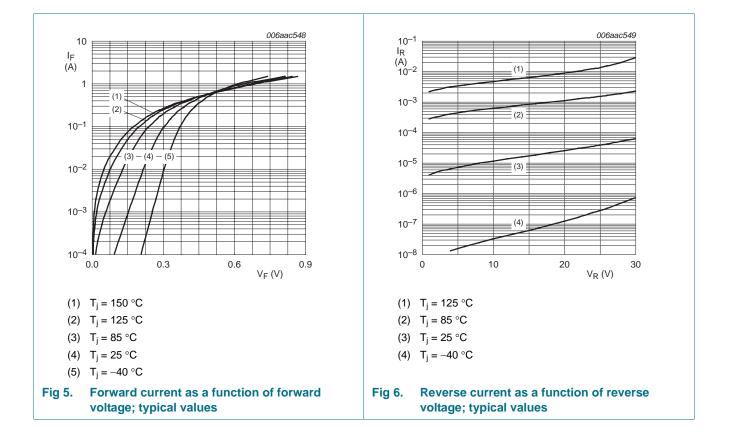
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7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|-----------------------|---------------------------------|------------|-----|-----|------|
| V _F | forward voltage | | <u>[1]</u> | | | |
| | | I _F = 0.1 mA | - | 90 | 180 | mV |
| | | I _F = 1 mA | - | 150 | 200 | mV |
| | | I _F = 10 mA | - | 210 | 270 | mV |
| | | I _F = 100 mA | - | 300 | 360 | mV |
| | | I _F = 500 mA | - | 450 | 500 | mV |
| I _R | reverse current | V _R = 10 V | - | 15 | 200 | μΑ |
| | | V _R = 30 V | - | 80 | 500 | μΑ |
| C _d | diode capacitance | V _R = 1 V; f = 1 MHz | - | 21 | 30 | pF |
| t _{rr} | reverse recovery time | | [2] _ | 6 | - | ns |

[2] When switched from $I_F = 10 \text{ mA}$ to $I_R = 10 \text{ mA}$; $R_L = 100 \Omega$; measured at $I_R = 1 \text{ mA}$.

. . . .

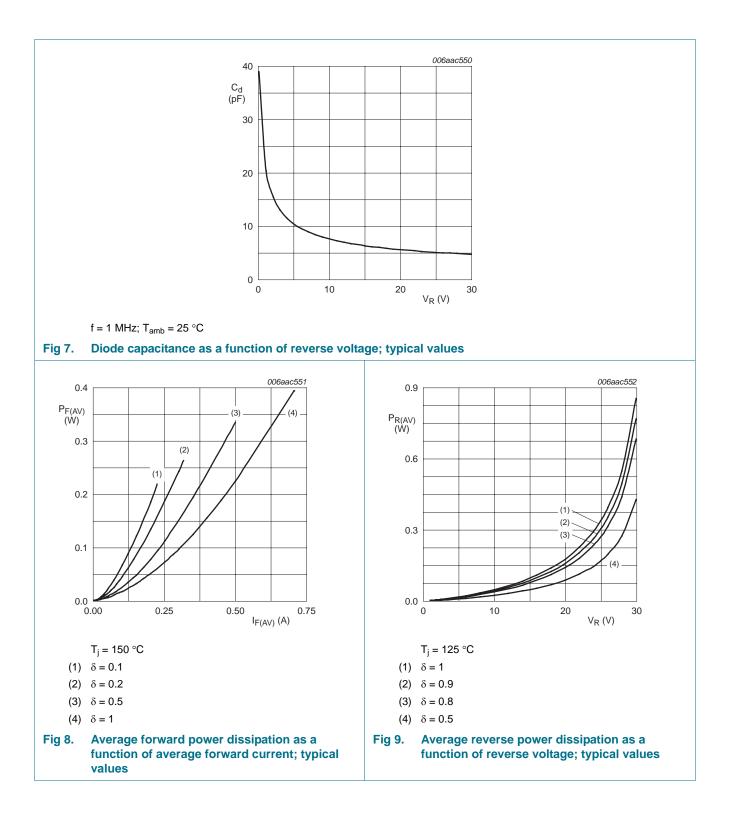


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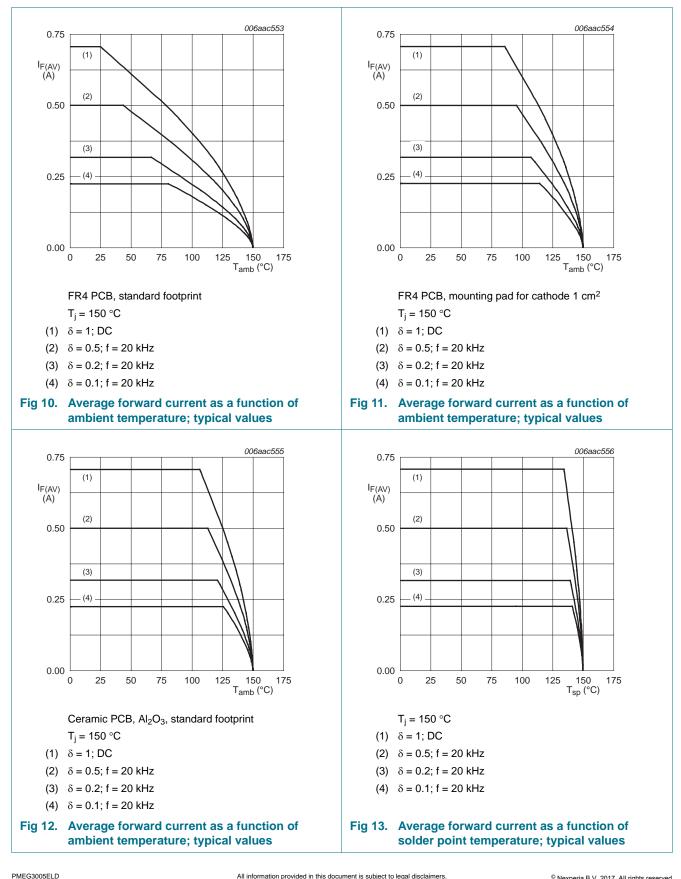
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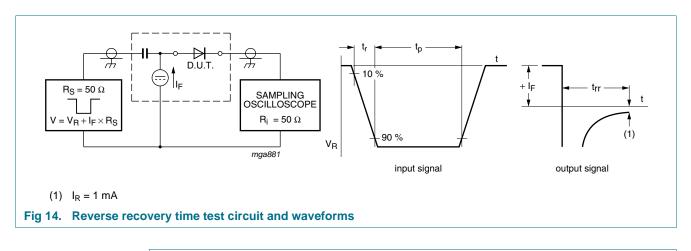
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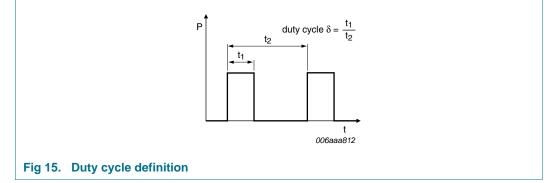


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8. Test information





The current ratings for the typical waveforms as shown in Figure 10, 11, 12 and 13 are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current,

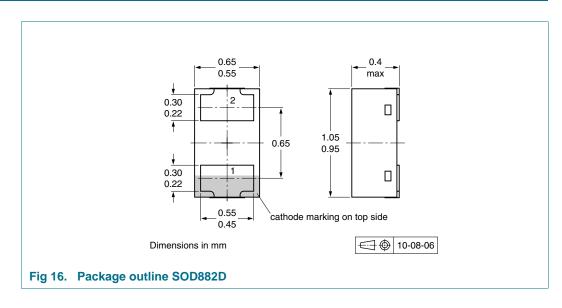
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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9. Package outline



10. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description | Packing quantity |
|-------------|---------|--------------------------------|------------------|
| | | | 10000 |
| PMEG3005ELD | SOD882D | 2 mm pitch, 8 mm tape and reel | -315 |

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

1.4 0.2 solder lands solder resist 0.8 06 07 (2×) (2×) (2×) solder paste Dimensions in mm 0.3 0.4 1.3 sod882d fr Reflow soldering is the only recommended soldering method. Fig 17. Reflow soldering SOD882D

11. Soldering



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12. Revision history

| Table 9. Revision hist | Revision history | | | | |
|------------------------|------------------|--------------------|---------------|------------|--|
| Document ID | Release date | Data sheet status | Change notice | Supersedes | |
| PMEG3005ELD v.1 | 20110412 | Product data sheet | - | - | |

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13. Legal information

13.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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